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08-08-01

PTO/SB/29 (1/98)

Approved for use through 09/30/00. OMB 0651-0032

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## UTILITY PATENT APPLICATION

Attorney Docket No.	AB-878-1D US		
First Named Inventor or Application Identifier	Sang-Guen Kim, Seung-Chul Ahn		
Title	Die Bonding Equipment (As Amended)		
Express Mail Label No.	EL 699 358 013 US		

·	Application ident		D: D :: T	· · · · · · · · · · · · · · · · · · ·				
TRANSMITTAL	Title		Die Bonding Equipment (As Amended)					
(Only for new nonprovisional applications under 37 CFR 1.53(b))	Express Mail Lab	el No. EL 699 358 013 US						
APPLICATION ELEMENTS See MPEP chapter 600 concerning utility patent application contents			ADDRESS TO: Commissioner for Patents Box Patent Application Washington, D.C. 20231					
APPLICATION ELEMENTS  1.  Fee Transmittal Form - see page 2 of this form. (Submit an original, and a duplicate for fee processing)  2. Application:  Specification: (preferred arrangement set forth below)  Descriptive title of the Invention,  Cross References to Related Applications,  Reference to Microfiche Appendix,  Background of the Invention,  Brief Summary of the Invention,  Brief Description of the Drawings, and  Detailed Description (all totaling 15 pages)  Appendix(ces), &pages)  Claim(s)								
<u></u>		16.	Request To Am	nend Drawings Under 37 C.F.R. § 1.121 e 6B amended as shown in red ink.				
Copy of Figure 6B amended as shown in red ink.  17. If a CONTINUING APPLICATION, check appropriate box and supply the requisite information and a preliminary amendment:  □ Continuation □ Divisional of prior application No. 09/406,916  Filed on September 24, 1999 , entitled: Die Bonding Method For Manufacturing Fine Pitch Ball Grid Array Packages .  PRIOR APPLICATION INFORMATION: Examiner Scott B. Geyer Group Art Unit 2813  **TORRESPONDENCE APPRESS**								
18. CORRESPONDENCE ADDRESS								
☐ Customer Number or Bar Code Label			or 🛛 Correspondence address below					
Name David W. Heid		Reg. No. 25,875						
Attorneys for Applicant  Skjerven Morrill MacPherson LLP								
Address 25 Metro Drive, Su	ite 700							
City San Jose		ate (	CA Zip C					
1 010)	Telephone (408	) 453-920	00 Fax	(408) 453-7979				

## 19. Fee calculations.

CLAIMS (Number Filed)	(1) FOR	(2)		(3) NUMBER EXTRA		(4) RATE		(5) CALCULATIONS
5	TOTAL CLAIMS (37 CFR 1.16(c))	-20	=	0	х	\$18	=	\$ 000
	INDEPENDENT CLAIMS (37 CFR 1.16(b))	-3	=	0	x	\$80	=	\$ 0 00
		LAIMS (if appli	MS (if applicable) (37 CFR 1.18(d)) + \$260 00					
			BASIC FEE (37 CFR 1.16(a))				=	\$ 710 00
			Total of above Calculations				=	\$ 710 00
	Reduction by 50% for filing by small entity (Note 31 CFR 1 9, 1 27, 1.28)						=	
	TOTAL						=	\$ 710 00

b. c. 21.	19-2386:  Fees required ur Fees required ur Other:  The prior	ner is hereby authorized to conder 37 CFR 1.16. (U.S. Appeder 37 CFR 1.17. (Conditional and and application's correspondence address is provided	plication Filing Fee onal Extension of Ti ssue Fees) ence address will	es) ime Fees)			
	OPPESBONDENC	E ADDRECC					
111	ORRESPONDENCE		, , , , , , , , , , , , , , , , , , , ,	□ <i>N</i>	ew correspondence address below		
NAME							
ADDRESS		OT A TP		ZIP CODE			
CITY	,	STATE TELEPHONE		FAX			
COUNTRY		TELETHONE			- 1		
	23. SIGNATURE	OF APPLICANT, ATTOR	NEY, OR AGENT	REQUIRED			
7 Water 1	Skjerven Morrill MacPherson LLP 25 Metro Drive, Suite 700						
	San Jose, CA 95110						
	Tel. (408) 453-9200 Fax. (408) 453-7979						
*	Date:	August 6, 2001	<u> </u>				
	Name	David W. Heid, Esq.		Reg. No. 25,875			
	Signature	Don't Wi).	Deid				
	Express Mail						
	Label No.	EL 699 358 013 US					